

Surface Mount Schottky Bridge Rectifiers
REVERSE VOLTAGE: 20 - 100 V
MB12S-MB110S
FEATURES

High Temperature Soldering Guaranteed: 260 C/10 Second

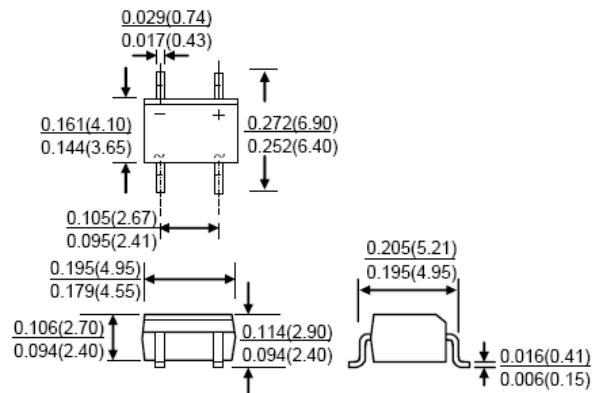
Saves Space On Printed Circuit Board

MECHANICAL DATA

Case: MBS

Epoxy: UL94V-O rate flame retardant

Lead: Lead Formed for Surface Mount

MBS (TO-269AA)

Dimensions in inches and (millimeters)
Maximum Ratings (T_c=25°C unless otherwise noted)

Parameter	Symbol	MB12S	MB14S	MB16S	MB18S	MB110S	Unit
Maximum repetitive peak reverse voltage	VRRM	20	40	60	80	100	V
Working peak reverse voltage	VRWM	14	28	42	56	70	V
Maximum DC blocking voltage	VDC	20	40	60	80	100	V
Maximum average forward rectified current Total device	IF(AV)				1		A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	IFSM				30		A
Operating junction temperature range	TJ			-55 to +150			°C
Storage temperature range	TSTG			-55 to +150			°C

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Electrical characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Value					Unit
Maximun instantaneous at IF=1A, T _j =25°C	VF	0.50	0.50	0.70	0.85	0.85	V
Maximum reverse current T _j =25°C	IR	500					u'A
at working peak reverse voltage T _j =125°C		20					m'A

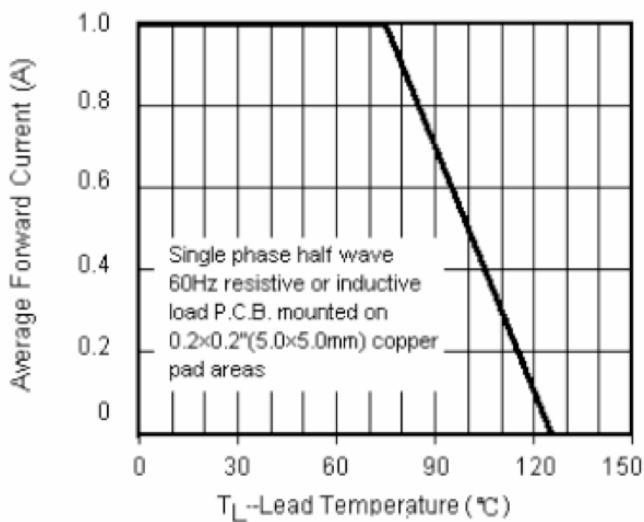
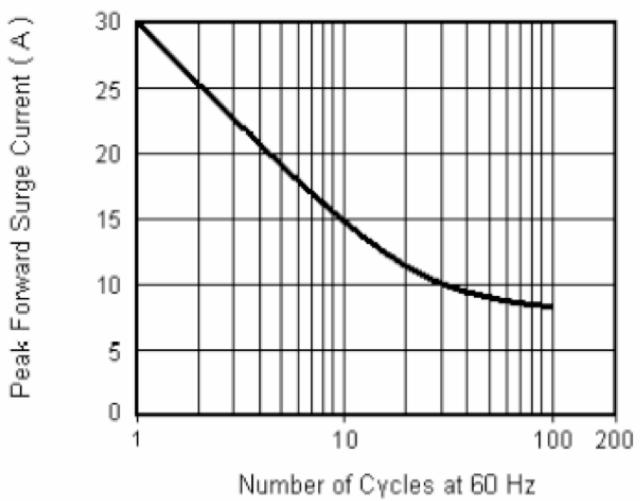
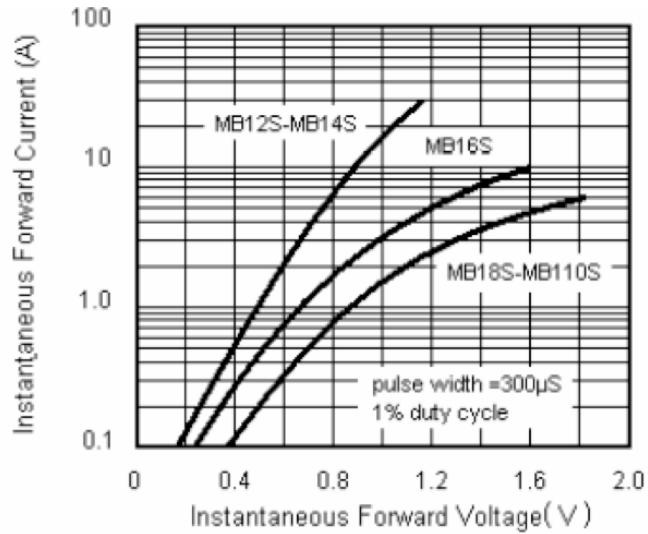
Thermal characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol			Unit
Typical thermal resistance	R _{θJA}	85		°C/W
	R _{thjl}	28		

NOTE :

- 1.Pulse test: Pulse width 300us, duty cycle 1%

Ratings and Characteristic Curves

FIG. 1 FORWARD DERATING CURVE

FIG. 2 PEAK FORWARD SURGE CURRENT

FIG. 3 TYPICAL FORWARD CHARACTERISTICS

FIG. 4 TYPICAL JUNCTION CAPACITANCE
